

SEMICONDUCTOR

200 mW DO-35 Hermetically Sealed Glass Fast Switching Schottky Barrier Diode

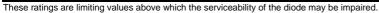


DEVICE MARKING DIAGRAM

L = Logo Device Code = BAT42 / BAT43

Absolute Maximum Ratings $T_A = 25$ °C unless otherwise noted

Symbol	I Parameter		Units	
P _D	Power Dissipation	200	mW	
T _{STG}	Storage Temperature Range	mperature Range -65 to +125		
TJ	Operating Junction Temperature	ating Junction Temperature +125		
V _{RRM}	Repetitive Peak Reverse Voltage	30	V	
V _R	Maximum DC Blocking Voltage	30	V	
I _{F(AV)}	Average Forward Rectified Current	200	mA	
I _{FSM}	Peak Forward Surge Current	4	А	



Cathode Anode

ELECTRICAL SYMBOL

Specification Features:

- Low Forward Voltage Drop
- DO-35 Package (JEDEC)
- Through-Hole Device Type Mounting
- Hermetically Sealed Glass
- Compression Bonded Construction
- All External Surfaces Are Corrosion Resistant And Leads Are Readily Solderable
- RoHS Compliant
- Solder Hot Dip Tin (Sn) Lead Finish

Electrical Characteristics T_A = 25°C unless otherwise noted

Cumbal	Parameter	Test Condition	Limits		l lmi4
Symbol	Parameter		Min	Max	Unit
B _v	Breakdown Voltage	I _R =100μA	30		Volts
I _R	Reverse Leakage Current	V _R =25V		500	nA
V _F	Forward Voltage TCBAT42	I _F =10mA		0.40	
		I _F =50mA		0.65	
	TCBAT43	I _F =2mA	0.26	0.33	Volts
		I _F =15mA		0.45	
	TCBAT42, TCBAT43	I _F =200mA		1.0	
T _{RR}	Reverse Recovery Time	I _F =I _R =10mA			
		R _L =100Ω	5 (Ty	pical)	nS
		I _{RR} =1mA			
С	Capacitance	V _R =1V, f=1M _{HZ}	7 (Ty	pical)	pF





Package Outline

Package Case Outline

DO-35

	DO-35					
DIM	Millimeters		Inches			
	Min	Max	Min	Max		
Α	0.46	0.55	0.018	0.022		
В	3.05	5.08	0.120	0.200		
С	25.40	38.10	1.000	1.500		
D	1.53	2.28	0.060	0.090		

Notes:

All dimensions are within JEDEC standard.

This datasheet presents technical data of Tak Cheong's Schottky Diode. Complete specifications for the individual devices are provided in the form of datasheets. A comprehensive Selector Guide is included to simplify the task of choosing the best set of components required for a specific application. For additional information, please visit our website http://www.takcheong.com.

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